# BASIC BLADE & BEAM SOCKET

(0.50 mm) .0197" PITCH • BSH SERIES



## BSH Mates:

## **SPECIFICATIONS**

Insulator Material:
Black LCP
Contact Material:
Phosphor Bronze
Plating:
Au or Sn over
50 μ" (1.27 μm) Ni
Current Rating:
2 A per pin
(2 pins powered)
Operating Temp Range:
-55 °C to +125 °C
Voltage Rating:
175 VAC
Max Cycles:
100

## **PROCESSING**

# Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (030-090) (0.15 mm) .006" max (120-150)\* \*(.004" stencil solution may be available; contact IPG@samtec.com)

## **Board Stacking:**

For applications requiring more than two connectors per board or 90 positions or higher, contact ipg@samtec.com

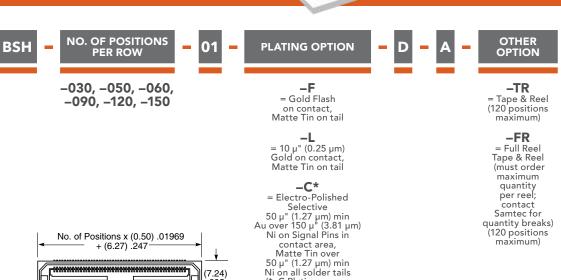
# ALSO AVAILABLE MOQ Required

 $30~\mu^{\rm w}$  (0.76  $\mu m)$  Gold Edge Mount Capability 8 mm, 11 mm, 16 mm, 19 mm and 22 mm Stack Height (Caution: Some automatic placement/inspection machines may have component height restrictions. Please consult machinery specifications.) (11 mm, 16 mm, 19 mm and 22 mm not available with 50 positions)

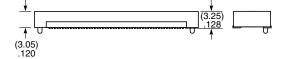


#### Note

Some lengths, styles and options are non-standard, non-returnable.



(\*–C Plating passes 10 year MFG testing)



.285

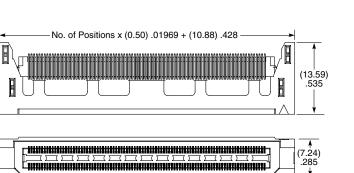


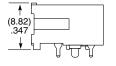
\*Processing conditions will affect mated height.



= Gold Flash on contact, Matte Tin on tail

> **-L** = 10 μ" (0.25 μm) Gold on contact, Matte Tin on tail





Post